

The Delphion Integrated View

Other Views:

INPADOC | Derwent...

Title:

JP63308080A2: INDUCTION HEATING BONDING PROCESS AND COMPOSITE ADHESIVE AND INDUCTION HEATING BONDING APPARATUS THEREFOR

Country:

JP Japan

Kind: A

Inventor(s):

**MIYAMOTO MICHIE** 

Applicant/Assignee:

**MIYAMOTO MICHIE** 

News, Profiles, Stocks and More about this company

Issued/Filed Dates:

Dec. 15, 1988 / Jan. 25, 1988

Application Number:

JP1988000015216

IPC Class:

C09J 5/00; B29C 65/04;

Priority Number(s):

Jan. 26, 1987 JP1987000016790

Abstract:

C.H.I.

Business Intelligence Reports

Purpose: To enable quick and easy bonding of parts without heating unnecessary parts, by passing a magnetic field energy through the bonding face between bonding objects and converting the magnetic energy into heat generated by eddy current loss, thereby melting and vulcanizing the resin at the surface of the bonding objects. accelerating the reaction and evaporating the solvent. Constitution: A part A to be bonded (e.g. carpet face material) 4 and a part B (e.g. carpet backing) 5 are supplied through respective feeding rolls 10, 12 and an electrically conductive heat-generation material 1 is supplied with a feeding roll 11 between the parts 4 and 5. The sheets are laminated with tension rolls 13, 14 and a high-frequency current is passed through an electromagnetic inductionheating coil 3 to generate magnetic field. The magnetic field energy passed through the parts is converted to heat generated by eddy current loss by an dielectric heatgeneration material 1 to effect the melting, vulcanization, acceleration of reaction and evaporation of solvent in the resin on the surface of the bonding object to obtain adhesive surfaces. The adhesive parts are bonded with each other and wound with a winding rill 15 to obtain a composite product composed of the parts A and B bonded with each other.

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<u>View</u> <u>Image</u>

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## INDUCTION HEATING BONDING PROCESS AND COMPOSITE ADHESIVE AND ... Page 2 of 2

Family: Show known family members

Other Abstract Info: DERABS C89-035369 DERC89-035369

Foreign References: No patents reference this one







Nominate this for the Gallery...

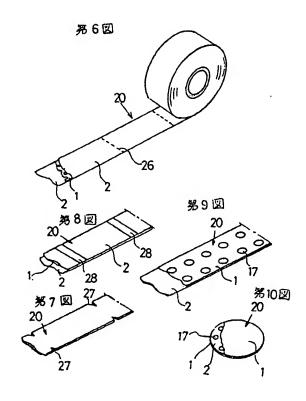
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## 特開昭63-308080(8)

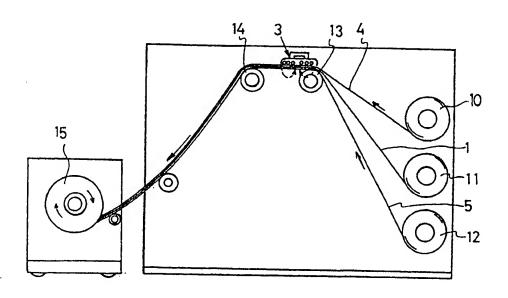
- (5) 裏打ち材シート
- (15) 容を取りロール
- (10)(11)(12) 供給ロール
- ..., ..., ...
- (17) 貫通穴
- (18) 押圧ロール
- (20) 辨聊加熱型接 剂
- (32) 給電部
- (34) 出力調整部
- (35) 検知部
- (36) 液探割御部

以上

出國人 宫本倫 枝

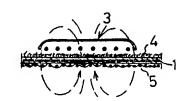


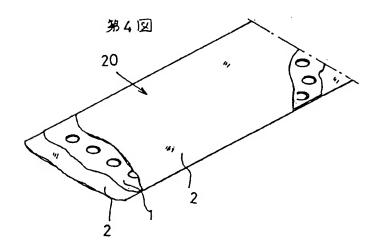
第1図



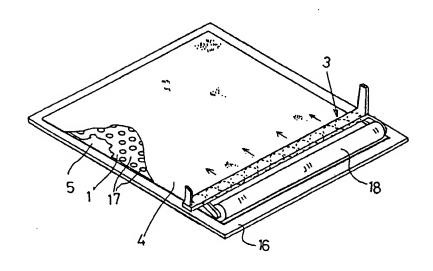
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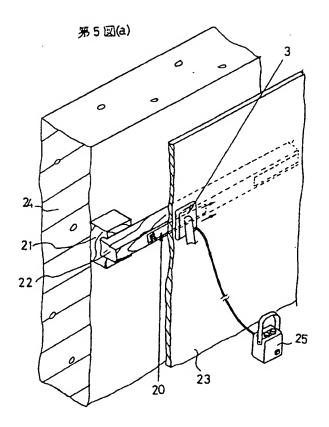




第3回



## **狩開昭63-308080 (10)**



第5図(b)

